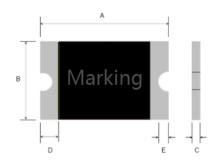
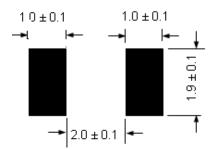


SMD1206-025-24V

Shape and Size





Terminal pad materials: Tin-Plated Nickle-copper

Terminal pad solderability: Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.

Dimention(Unit : mm)

Ī	Model	А		В		С		D	E
	Model	Min.	Max.	Min.	Max.	Min.	Max	Min.	Min.
	SMD1206-025-24v	3.00	3.50	1.50	1.80	0.80	1.90	0.15	0.10

Performance Ratings:

Madal		lmax	Ihold @25℃ (A)	Itrip @25℃ (A)	Pd Typ (W)	Maximum Time To Trip		Resistance		
Model		(A)				Current (A)	Time (Sec)	Rimin (Ω)	Rityp (Ω)	R1max (Ω)
						(A)	(360)	(22)	(22)	(22)
SMD1206-025	24	40	0.25	0.5	0.6	8.0	0.08	0.35	0.7	2.7

Test Conditons and Standards:

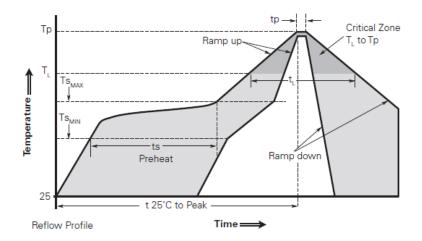
Item	Test Conditon	Standard		
Initial Resistance	25℃	0.3500~2.7Ω		
IH	25℃,0.25A,60min	No Trip		
Ttrip	25℃,8.0A	≤0.08s		
Trip endurance	24V,40A,1hr	No arcing or burning		

Operating Temperature: -40°C TO 85°C

Packaging: Bulk 5000 pcs per bag

Solder Reflow Conditions





Profile Feature	Pb-Free Assembly	 Recommended reflow methods: IR, vapor 			
• Average ramp up rate(TS _{MAX} to TP)	3°C/Second max	phase			
Preheat		oven, hot air oven, N2 environment for			
●Temperature min (TS _{MIN})	150 ℃	lead-free.			
●Temperature max (TS _{MAX})	200℃	 Devices are not designed to be wave 			
Time(TSMIN to TSMAX)	60-120 Seconds	soldered to			
Time maintained above:	the bottom side of the board.				
●Temperature(T _L)	217 ℃	 Recommended maximum paste thickness is 			
●Time(T _L)	60-150 Seconds	0.25mm (0.010inch).			
Peak/Classification temperature(TP)	260℃	 Devices can be cleaned using standard 			
Time within5°C of actual peak temperature		industry			
●Time(TP)	30 Seconds max	methods and solvents.			
•Ramp down rate	3°C Second max	Soldering temprature profile meets RoHs			
●Time 25 °C to peak temperature	8 minutes max	leadfree process.			

Note: All temperatures refer to topside of the package, measured on the package body

surface.

Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements

Storage

The maximum ambient temperature shall not exceed 38° C. Storage temperatures higher than 38° C could result in the deformation of packaging materials. The maximum relative humidity recommended for storage is 60%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components. Sealed plastic bags with desiccant shall be used to reduce the oxidation of the termination and shall only be opened prior to use. The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present

Trustworthy electronic circuit protection expert

Warning

Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.

Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices.PPTC SMD can be cleaned by standard methods.

· Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profilecould negatively impact solderability performance of our devices.

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